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# SPECIFICATION FOR LCD MODULE

**Customer** : \_\_\_\_\_

**Product Model:** YH080MH4003 V05

**Sample code:** \_\_\_\_\_

Designed by	Checked by	Approved by

## Final Approval by Customer

<input type="checkbox"/> <b>LCM Machinery OK</b>  Checked By _____  <input type="checkbox"/> <b>LCM Display OK</b>  Checked By _____	<input type="checkbox"/> <b>LCM OK</b>  <input type="checkbox"/> <b>NG , Problem survey:</b>  Approved By _____
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※The specification of “TBD” should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.

## Revision History

<b>Version</b>	<b>Content</b>	<b>Page</b>	<b>Date</b>
1.0	Generation first version	All	2016-10-10

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# 1. General Specifications

No.	Item	Specification	Remark
1	LCD size	8.0 inch diagonal	
2	Driver element	a-Si TFT active matrix	
3	Resolution	1024 × 3(RGB) × 768	
4	Display mode	Normally Black, Transmissive	
5	Dot pitch	0.05275(W) × 0.15825(H) mm	
6	Active area	162.05(W) × 121.54(H) mm	
7	Module size	183.00 (W) × 141.00(H) × 5.6(D) mm	Note 1
8	Surface treatment	Hard Coating	
9	Color arrangement	RGB-stripe	
10	Interface	LVDS	
11	Backlight power consumption	3.456W	
12	Panel power consumption	0.383W	
13	Weight	TBD	

Note 1: Refer to Mechanical Drawing.

## 2. Pin Assignment

### 2.1 CN1 (Input Signal)

Pin No.	Symbol	I/O	Function	Remark
1	VCOM	P	Common Voltage	
2	VDD	P	Power Voltage for digital circuit	
3	VDD	P	Power Voltage for digital circuit	
4	NC	---	No connection	
5	Reset	I	Global reset pin	
6	STBYB	I	Standby mode, Normally pulled high STBYB = "1", normal operation STBYB = "0", timing controller, source driver will turn off, all output are High-Z	
7	GND	P	Ground	
8	RXIN0-	I	- LVDS differential data input	
9	RXIN0+	I	+ LVDS differential data input	
10	GND	P	Ground	
11	RXIN1-	I	- LVDS differential data input	
12	RXIN1+	I	+ LVDS differential data input	
13	GND	P	Ground	
14	RXIN2-	I	- LVDS differential data input	
15	RXIN2+	I	+ LVDS differential data input	
16	GND	P	Ground	
17	RXCLKIN-	I	- LVDS differential clock input	
18	RXCLKIN+	I	+ LVDS differential clock input	
19	GND	P	Ground	
20	RXIN3-	I	- LVDS differential data input	
21	RXIN3+	I	+ LVDS differential data input	
22	GND	P	Ground	
23	NC	---	No connection	
24	NC	---	No connection	
25	GND	P	Ground	
26	NC	---	No connection	

27	DIMO	O	Backlight CABC controller signal output	
28	SELB	I	6bit/8bit mode select	Note1
29	AVDD	P	Power for Analog Circuit	
30	GND	P	Ground	
31	LED-	P	LED Cathode	
32	LED-	P	LED Cathode	
33	L/R	I	Horizontal inversion	Note3
34	U/D	I	Vertical inversion	Note3
35	VGL	P	Gate OFF Voltage	
36	CABCEN1	I	CABC H/W enable	Note2
37	CABCEN0	I	CABC H/W enable	Note2
38	VGH	P	Gate ON Voltage	
39	LED+	P	LED Anode	
40	LED+	P	LED Anode	

I: input, O: output, P: Power

Note1: If LVDS input data is 6 bits ,SELB must be set to High;

If LVDS input data is 8 bits ,SELB must be set to Low.

Note2: When CABC\_EN="00", CABC OFF.

When CABC\_EN="01", user interface image.

When CABC\_EN="10", still picture.

When CABC\_EN="11", moving image.

When CABC off, don't connect DIMO, else connect it to backlight.

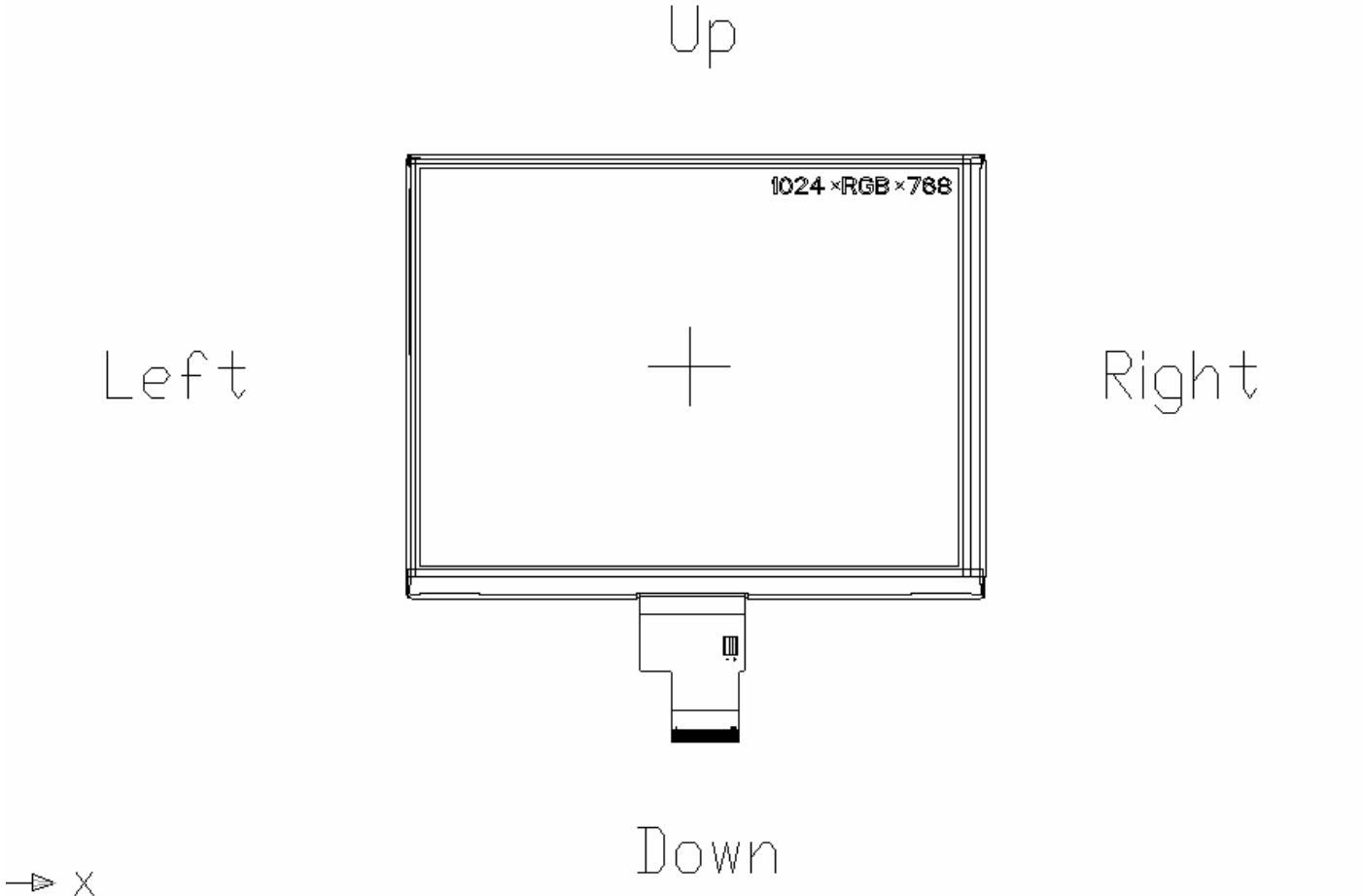
Note3: When L/R="0", set right to left scan direction.

When L/R="1", set left to right scan direction.

When U/D="0", set top to bottom scan direction.

When U/D="1", set bottom to top scan direction.

Note: Definition of scanning direction.  
Refer to the figure as below:



## 3. Operation Specifications

### 3.1. Absolute Maximum Ratings

(GND=AV<sub>SS</sub>=0V,Note 1)

Item	Symbol	Values		Unit	Remark
		Min.	Max.		
Power voltage	VCC	-0.3	5.0	V	GND=0V, TA=25°C
	AVDD	6.5	13.5	V	
	V <sub>GH</sub>	-0.3	40.0	V	
	V <sub>GL</sub>	-20.0	0.3	V	
	V <sub>GH</sub> -V <sub>GL</sub>	-	40.0	V	
Operation Temperature	T <sub>OP</sub>	-10	50	°C	
Storage Temperature	T <sub>ST</sub>	-20	60	°C	
LED Reverse Voltage	V <sub>R</sub>	-	3	V	Each LED
LED Forward Current	I <sub>F</sub>	-	50	mA	Each LED

Note 1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

### 3.2. Typical Operation Conditions

(GND=AV<sub>SS</sub>=0V, Note 1)

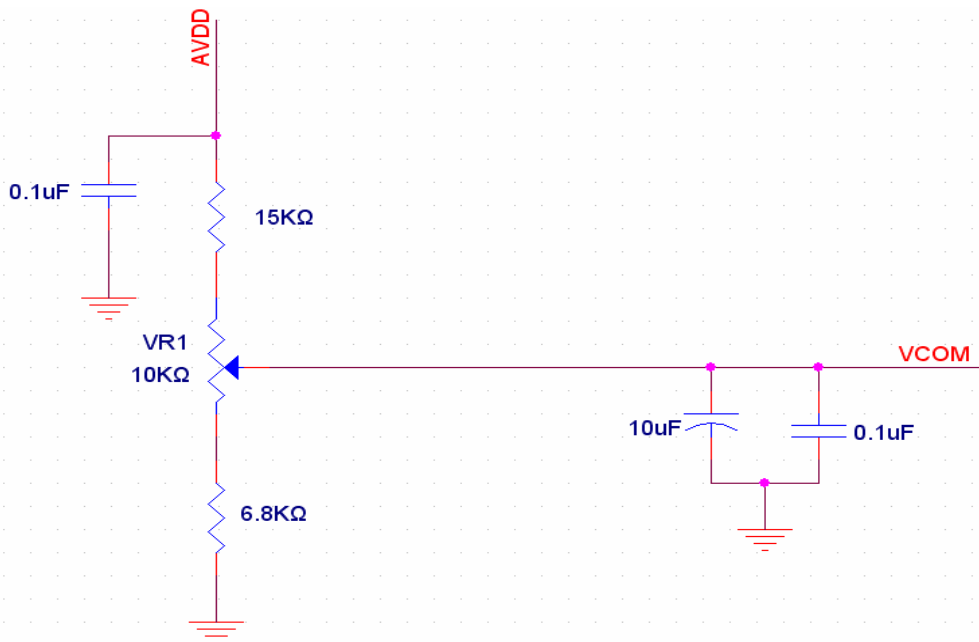
Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Power voltage	V <sub>CC</sub>	3.0	3.3	3.6	V	Note 2
	AV <sub>DD</sub>	9.8	10	10.2	V	
	V <sub>GH</sub>	18.6	18.9	19.2	V	
	V <sub>GL</sub>	-8.1	-7.8	-7.5	V	
Input signal voltage	V <sub>COM</sub>	2.6	3.6	4.6	V	Note 3
Input logic high voltage	V <sub>IH</sub>	0.7V <sub>CC</sub>	-	V <sub>CC</sub>	V	Note 4
Input logic low voltage	V <sub>IL</sub>	0	-	0.3V <sub>CC</sub>	V	

Note 1: Be sure to apply V<sub>DD</sub> and V<sub>GL</sub> to the LCD first, and then apply V<sub>GH</sub>

Note 2: V<sub>DD</sub> setting should match the signals output voltage (refer to Note 3) of customer's system board.

Note 3: Typical V<sub>com</sub> is only a reference value, it must be optimized according to each LCM, please use VR and base on below application circuit..

Note 4: RESET, STBYB, SELB, L/R, U/D, CAB<sub>CEN0</sub>, CAB<sub>CEN1</sub>.



### 3.3. Current Consumption

(GND=AVSS=0V)

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Current for Driver	$I_{GH}$	-	0.65	1.0	mA	VGH=18.9V
	$I_{GL}$	-	0.65	1.0	mA	VGL=-7.8V
	$I_{CC}$	-	35	60	mA	Vcc=3.3V
	$I_{AVDD}$	-	25	40	mA	AVDD=10.0V

### 3.4. Backlight Driving Conditions

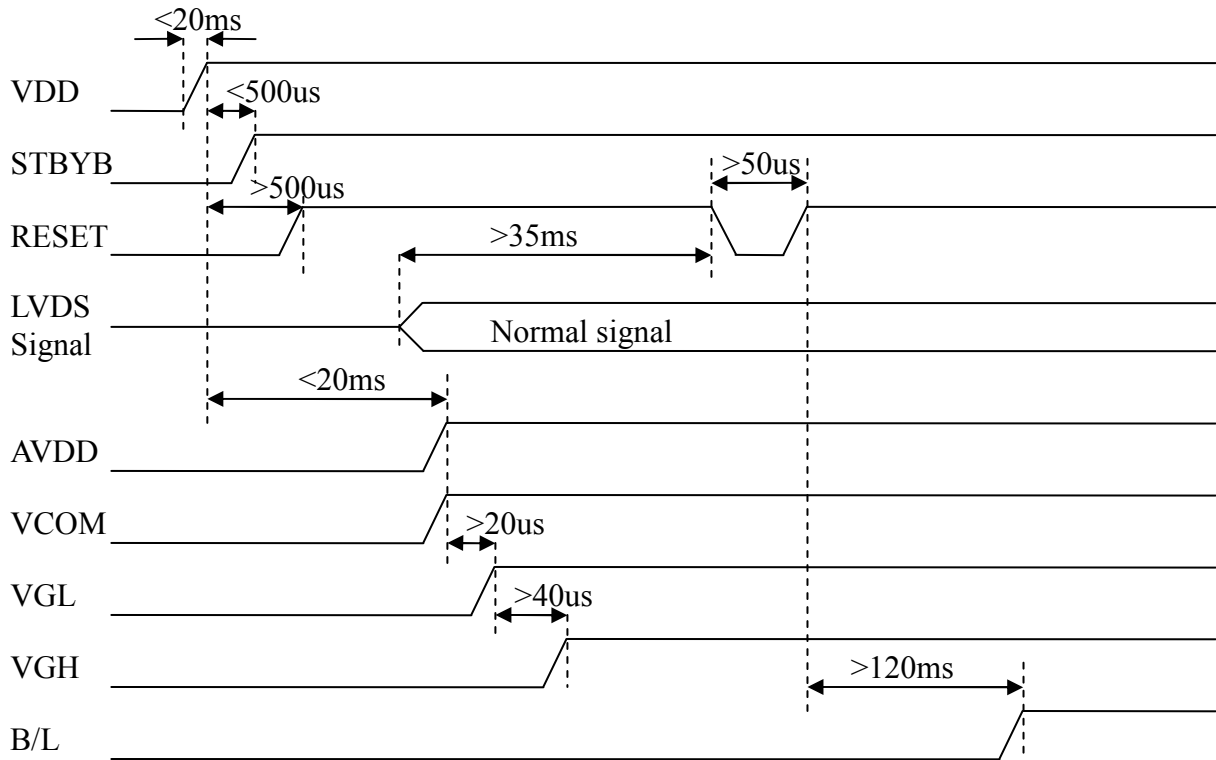
Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Voltage for LED backlight	$V_L$	8.40	9.60	10.50	V	Note 1
Current for LED backlight	$I_L$	200	250	300	mA	3*12 LED
LED life time	-	-	20,000	-	Hr	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at  $T_a=25^{\circ}\text{C}$  and  $I_L=250\text{mA}$ .

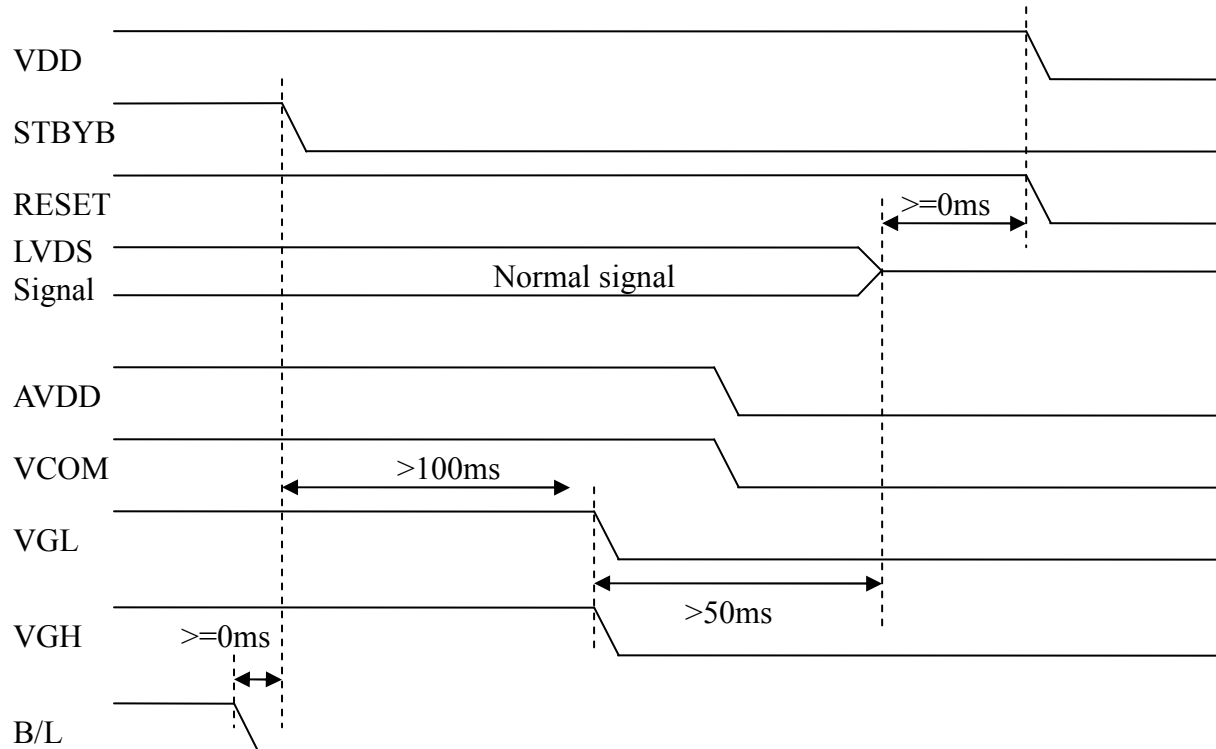
Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at  $T_a=25^{\circ}\text{C}$  and  $I_L=250\text{mA}$ . The LED lifetime could be decreased if operating  $I_L$  is larger than 250mA.

### 3.5. Power Sequence

**a. Power on:**



**b. Power off:**

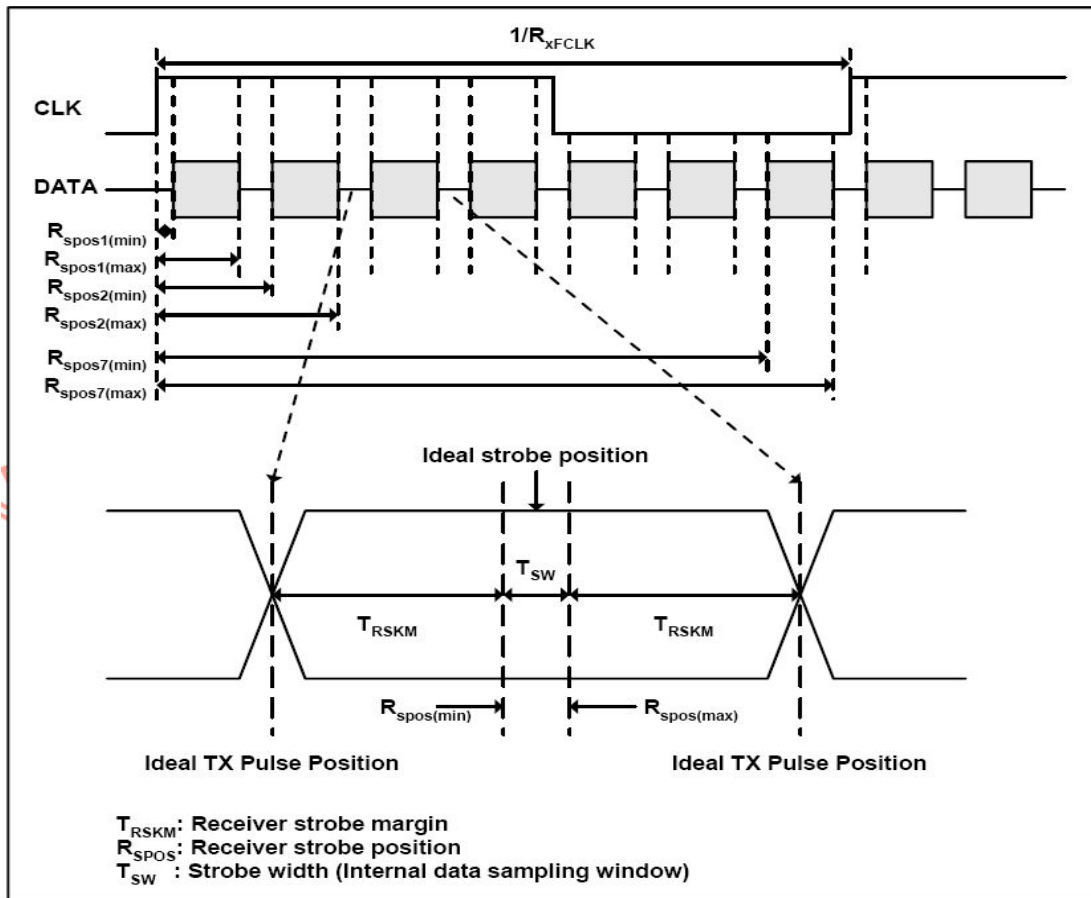


## 3.6. LVDS Signal Timing Characteristics

### 3.6.1. AC Electrical Characteristics

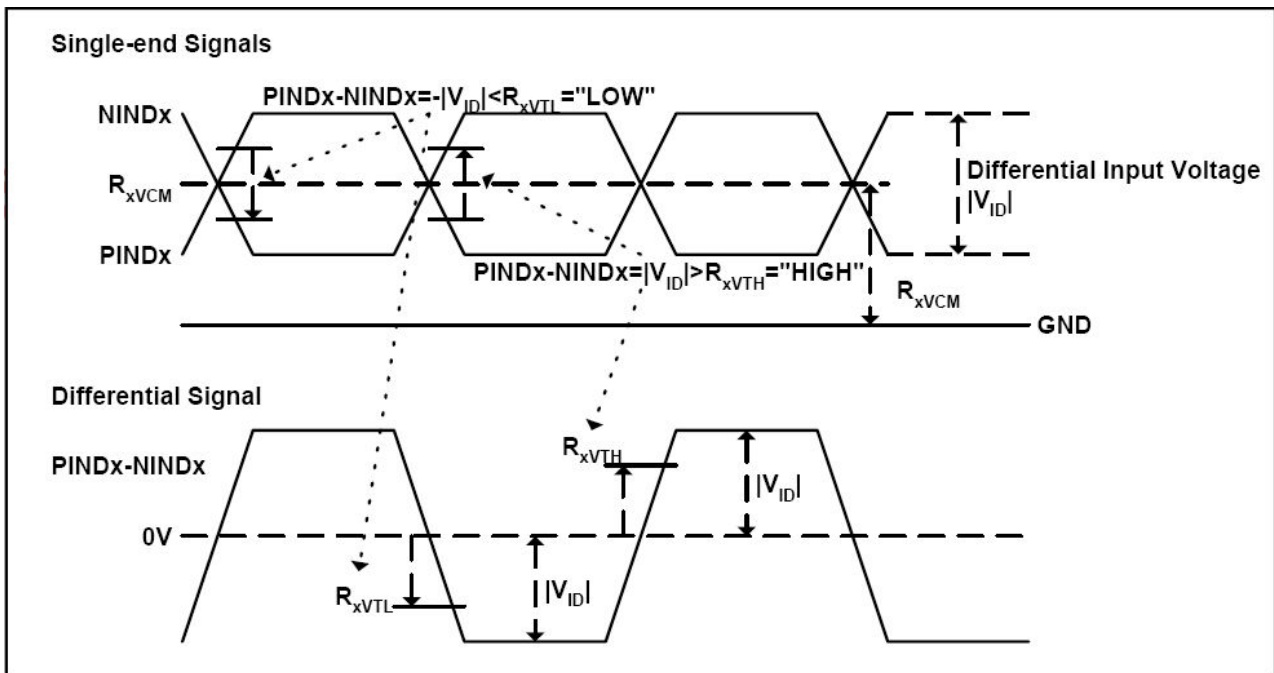
Parameter	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Clock frequency	$R_{x\text{FCLK}}$	20	-	71	MHz	
Input data skew margin	$T_{\text{RSKM}}$	500	-	-	ps	
Clock high time	$T_{\text{LVCH}}$	-	$4/(7 * R_{x\text{FCLK}})$	-	ns	
Clock low time	$T_{\text{LVCL}}$	-	$3/(7 * R_{x\text{FCLK}})$	-	ns	

### 3.6.2. Input Clock and Data Timing Diagram



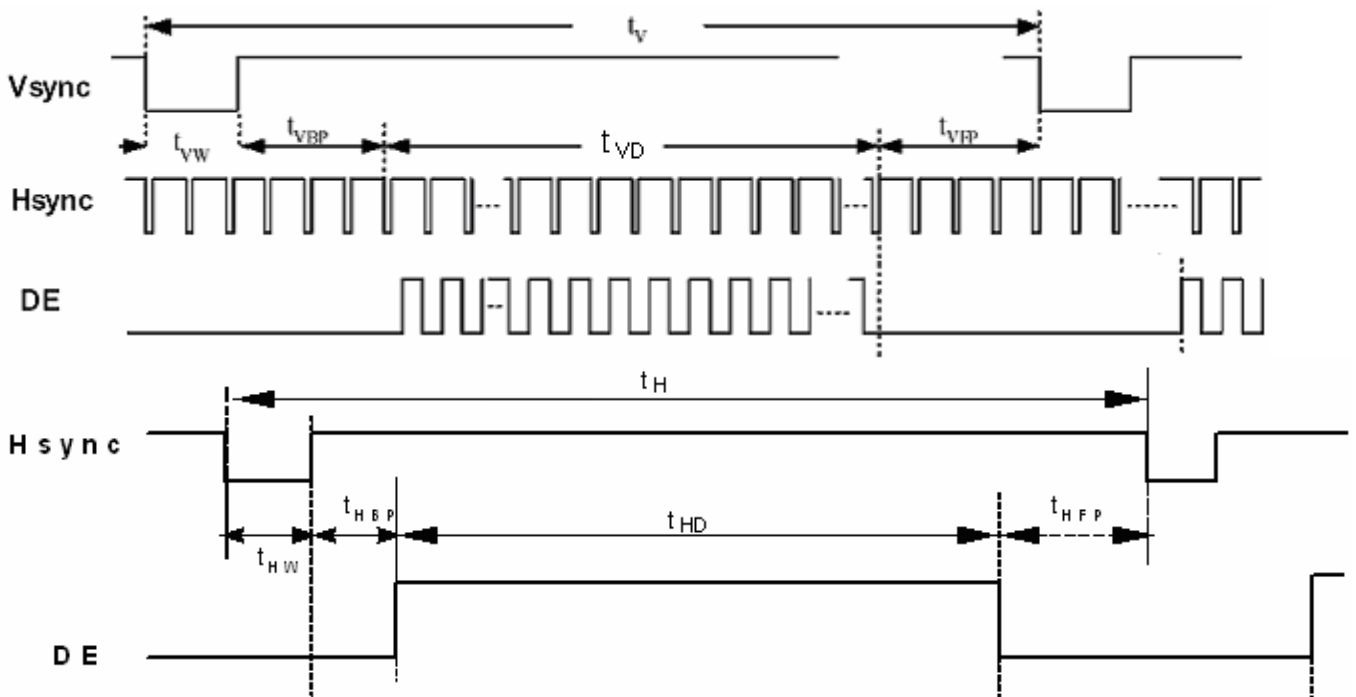
### 3.6.3. DC Electrical Characteristics

Parameter	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Differential input high Threshold voltage	$R_{xVTH}$	-	-	+0.1	V	$R_{xVCM}=1.2V$
Differential input low Threshold voltage	$R_{xVTL}$	-0.1	-	-	V	
Input voltage range (singled-end)	$R_{xVIN}$	0	-	2.4	V	
Differential input common mode voltage	$R_{xVCM}$	$ V_{ID} /2$	-	$2.4- V_{ID} /2$	V	
Differential voltage	$ V_{ID} $	0.2	-	0.6	V	
Differential input leakage current	$R_{V_{xIz}}$	-10	-	+10	$\mu A$	



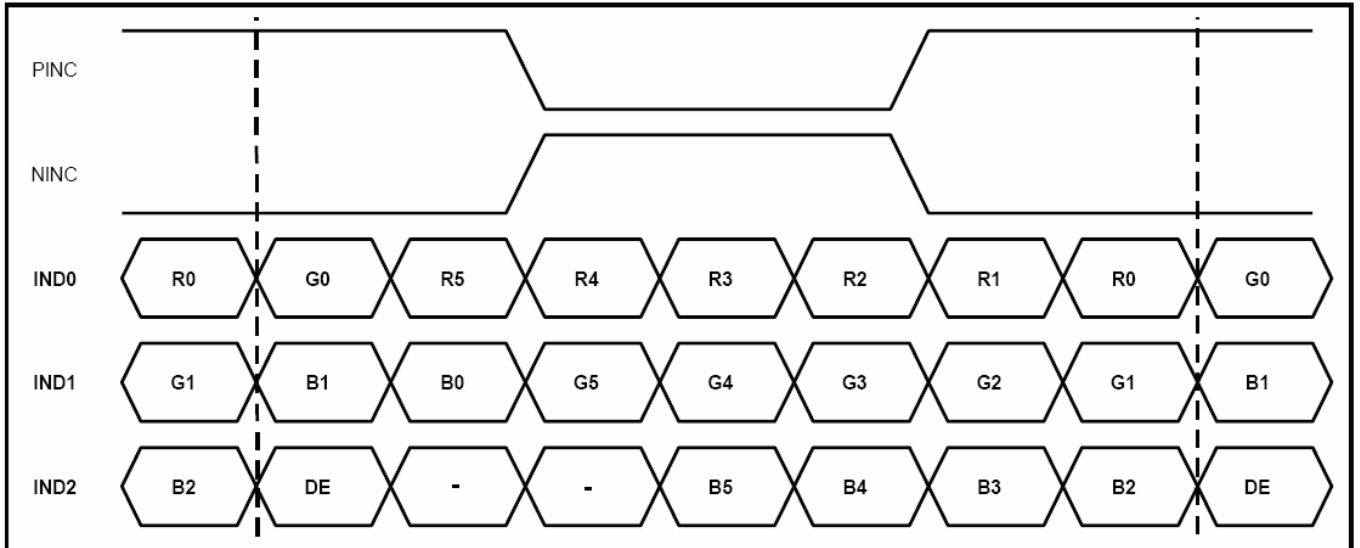
### 3.6.4. Timing Table

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Clock Frequency	fclk	52	65	71	MHz	Frame rate =TBD
Horizontal display area	thd	1024				
HS period time	th	1114	1344	1400	DCLK	
HS Blanking	thb+thfp	90	320	376	DCLK	
Vertical display area	tvd	768				
VS period time	tv	778	806	845	H	
VS Blanking	tvb+tvfp	10	38	77	H	

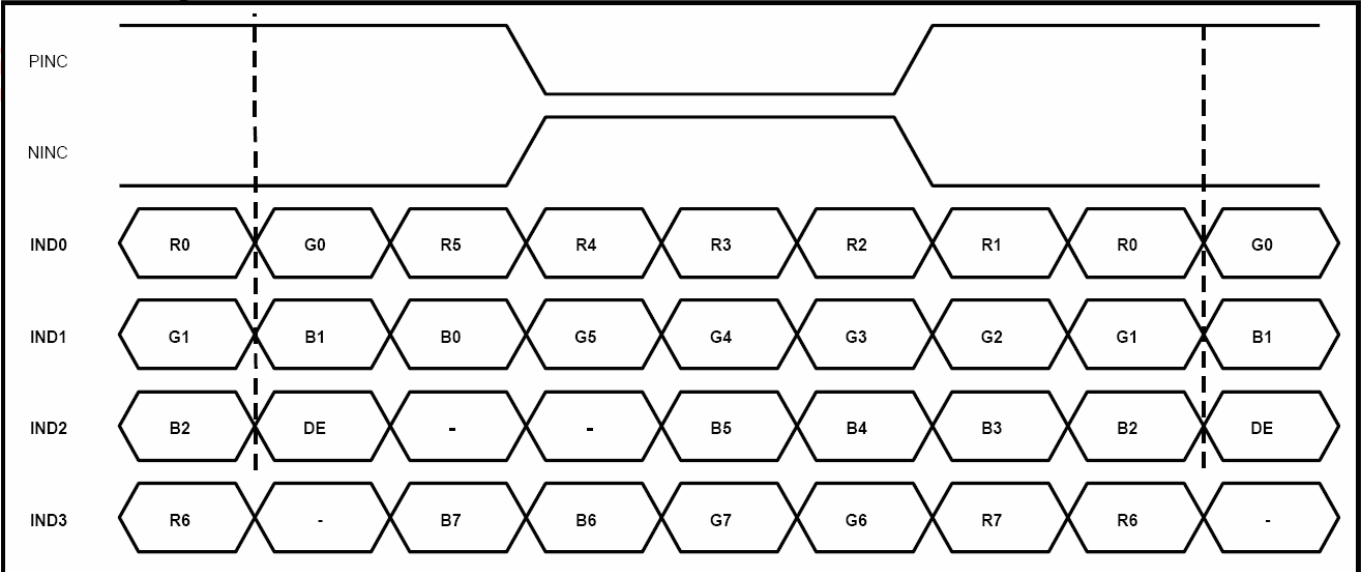


### 3.6.5. Data Input Format

#### 6bit LVDS input



#### 8bit LVDS input



Note: Support DE timing mode only, SYNC mode not supported

## 4. Optical Specifications

Item	Symbol	Condition	Values			Unit	Remark
			Min.	Typ.	Max.		
Viewing angle (CR≥ 10)	$\theta_L$	$\Phi=180^\circ$ (9 o'clock)	75	85	-	degree	
	$\theta_R$	$\Phi=0^\circ$ (3 o'clock)	75	85	-		
	$\theta_T$	$\Phi=90^\circ$ (12 o'clock)	75	85	-		
	$\theta_B$	$\Phi=270^\circ$ (6 o'clock)	75	85	-		
Response time	$T_{ON}$	Normal $\theta=\Phi=0^\circ$	-	25	50	msec	
	$T_{OFF}$						
Contrast ratio	CR		600	800	-	-	
Color chromaticity	$W_X$		0.260	0.295	0.330	-	
	$W_Y$		0.270	0.305	0.340	-	
Luminance	L		450	500	-	cd/m2	
Luminance uniformity	$Y_U$		75	80	-	%	
NTSC				50		%	

Test Conditions:

1.  $DV_{DD}=3.1V$ ,  $I_L=250mA$  (Backlight current), the ambient temperature is  $25^\circ C$ .
2. The test systems refer to Note 2.



## 6. General Precautions

### 6.1 Safety

The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

### 6.2 Handling

- A. The LCD and touch panel is made of plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.
- B. Do not handle the product by holding the flexible pattern portion in order to assure the reliability
- C. Transparency is an important factor for the touch panel. Please wear clear finger sacks, gloves and mask to protect the touch panel from finger print or stain and also hold the portion outside the view area when handling the touch panel.
- D. Provide a space so that the panel does not come into contact with other components.
- E. To protect the product from external force, put a covering lens (acrylic board or similar board) and keep an appropriate gap between them.
- F. Transparent electrodes may be disconnected if the panel is used under environmental conditions where dew condensation occurs.
- G. Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in IC malfunctions.
- H. To prevent such IC malfunctions, your design and mounting layout shall be done in the way that the IC is not exposed to light in actual use.

### 6.3 Static Electricity

- A. Ground soldering iron tips, tools and testers when they are in operation.
- B. Ground your body when handling the products.
- C. Power on the LCD module before applying the voltage to the input terminals.
- D. Do not apply voltage which exceeds the absolute maximum rating.
- E. Store the products in an anti-electrostatic bag or container.

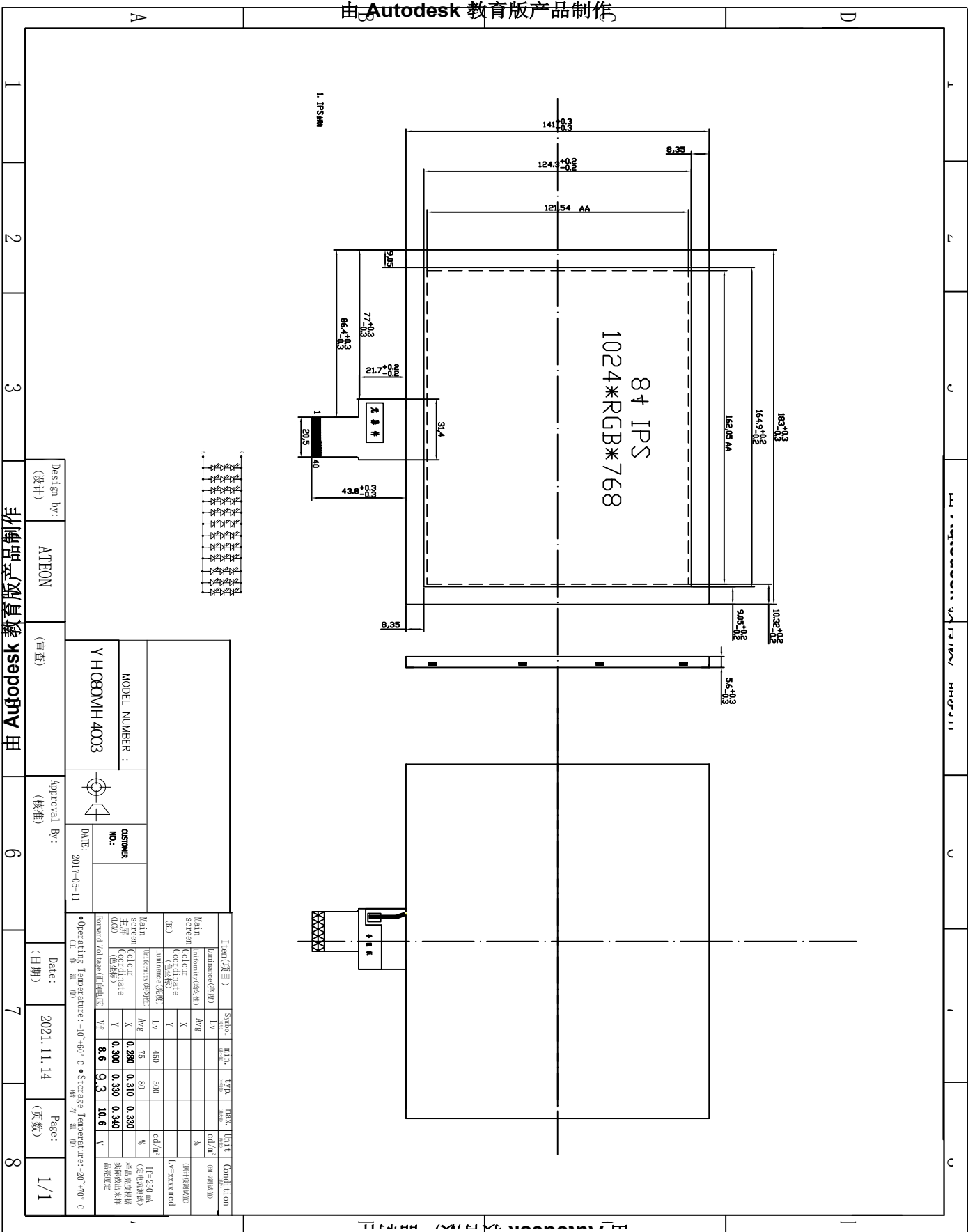
### 6.4 Storage

- A. Store the products in a dark place at  $+25^{\circ}\text{C}\pm 10^{\circ}\text{C}$  with low humidity (40% RH to 60% RH). Don't expose to sunlight or fluorescent light.
- B. Storage in a clean environment, free from dust, active gas, and solvent.

### 6.5 Cleaning

- A. Do not wipe the touch panel with dry cloth, as it may cause scratch.
- B. Wipe off the stain on the product by using soft cloth moistened with ethanol. Do not allow ethanol to get in between the upper film and the bottom glass. It may cause peeling issue or defective operation. Do not use any organic solvent or detergent other than ethanol.

# 7. Mechanical Drawing



## 8. Package Information

8.1 LCM quantity per Carton: 60 pcs

8.2 Package drawing:TBD